



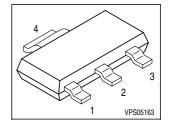


Features

- Logic Level Input
- Input Protection (ESD)
- Thermal shutdown with auto restart
- Green product (RoHS compliant)
- Overload protection
- Short circuit protection
- Overvoltage protection
- Current limitation
- Analog driving possible

Product Summary

Drain source voltage	$V_{\rm DS}$	42	V
On-state resistance	R _{DS(on)}	200	mΩ
Nominal load current	I _{D(Nom)}	1.4	Α
Clamping energy	E _{AS}	150	mJ

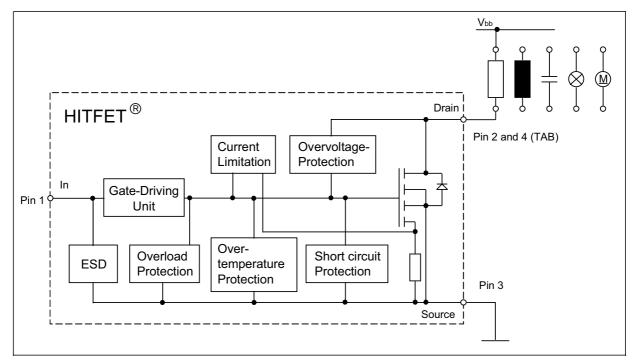


Application

- All kinds of resistive, inductive and capacitive loads in switching or linear applications
- μC compatible power switch for 12 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET in Smart SIPMOS® technology. Fully protected by embedded protection functions.



Complete product spectrum and additional information http://www.infineon.com/hitfet



Maximum Ratings at T_i = 25°C, unless otherwise specified

Parameter	Symbol	Value	Unit
Drain source voltage	V _{DS}	42	V
Supply voltage for full short circuit protection	V _{bb(SC)}	42	
Continuous input voltage ¹⁾	V_{IN}	-0.2 ²⁾ +10	
Continuous input current ²⁾	I _{IN}		mA
$-0.2V \le V_{IN} \le 10V$		self limited	
$V_{\rm IN}$ < -0.2V or $V_{\rm IN}$ > 10V		<i>I</i> _{IN} ≤ 2	
Operating temperature	Ti	-40+150	°C
Storage temperature	T _{stg}	-55 + 150	
Power dissipation ⁵⁾	P _{tot}	3.8	W
$T_{\rm C}$ = 85 °C			
Unclamped single pulse inductive energy ²⁾	E _{AS}	150	mJ
Load dump protection $V_{\text{LoadDump}}^{(2)3)} = V_{\text{A}} + V_{\text{S}}$	V_{LD}	50	V
$V_{\rm IN}$ = 0 and 10 V, t _d = 400 ms, $R_{\rm I}$ = 2 Ω ,			
$R_{L} = 9 \Omega, V_{A} = 13.5 V$			
Electrostatic discharge voltage ²⁾ (Human Body Model)	V _{ESD}	2	kV
according to Jedec norm			
EIA/JESD22-A114-B, Section 4			

Thermal resistance

junction - ambient:	R_{thJA}		K/W
@ min. footprint		125	
@ 6 cm ² cooling area ⁴⁾		72	
junction-soldering point:	R _{thJS}	17	K/W

¹For input voltages beyond these limits I_{IN} has to be limited.

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²not subject to production test, specified by design

 $^{^3}V_{
m Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

 $^{^4}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for drain connection. PCB mounted vertical without blown air.

 $^{^{5}}$ not subject to production test, calculated by $\rm R_{thJA}$ and $\rm R_{ds(on)}$



Electrical Characteristics

Parameter	Symbol	Values			Unit
at $T_j = 25$ °C, unless otherwise specified		min.	typ.	max.	
Characteristics					
Drain source clamp voltage	$V_{DS(AZ)}$	42	-	55	V
$T_{\rm j}$ = -40+ 150, $I_{\rm D}$ = 10 mA					
Off-state drain current	I _{DSS}				μΑ
$T_{\rm i}$ = -40+85 °C, $V_{\rm bb}$ = 32 V, $V_{\rm IN}$ = 0 V		-	1.5	8	
$T_{\rm j}$ = 150 °C		-	4	10	
Input threshold voltage	V _{IN(th)}				V
$I_{\rm D}$ = 0.3 mA, $T_{\rm j}$ = 25 °C		1.3	1.7	2.2	
$I_{\rm D}$ = 0.3 mA, $T_{\rm j}$ = 150 °C		0.8	-	-	
On state input current	I _{IN(on)}	-	10	30	μΑ
On-state resistance	R _{DS(on)}				mΩ
$V_{\rm IN}$ = 5 V, $I_{\rm D}$ = 1.4 A, $T_{\rm j}$ = 25 °C		-	190	240	
$V_{\rm IN}$ = 5 V, $I_{\rm D}$ = 1.4 A, $T_{\rm j}$ = 150 °C		-	350	480	
On-state resistance	R _{DS(on)}				
$V_{\rm IN}$ = 10 V, $I_{\rm D}$ = 1.4 A, $T_{\rm j}$ = 25 °C		-	150	200	
$V_{\rm IN}$ = 10 V, $I_{\rm D}$ = 1.4 A, $T_{\rm j}$ = 150 °C		_	280	400	
Nominal load current ⁵⁾		1.4	1.8	-	Α
$V_{\rm DS}$ = 0.5 V, $T_{\rm j}$ < 150°C, $V_{\rm IN}$ = 10 V, $T_{\rm A}$ = 85 °C					
Current limit (active if V _{DS} >2.5 V) ¹⁾	I _{D(lim)}	5	7.5	10	
$V_{\rm IN}$ = 10 V, $V_{\rm DS}$ = 12 V, $t_{\rm m}$ = 200 $\mu {\rm s}$					

¹Device switched on into existing short circuit (see diagram Determination of $b_{(lim)}$). If the device is in on condit and a short circuit occurs, these values might be exceeded for max. 50 μ s.

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 $^{^5 \}rm{not}$ subject to production test, calculated by $\rm{R_{thJA}}$ and $\rm{R_{ds(on)}}$



Electrical Characteristics

Parameter	Symbol	Values			Unit	
at T_j = 25°C, unless otherwise specified		min.	typ.	max.	1	
Dynamic Characteristics						
Turn-on time V_{IN} to 90% I_D :	t _{on}	-	45	100	μs	
$R_{L} = 4.7 \ \Omega, \ V_{IN} = 0 \text{ to } 10 \ V, \ V_{bb} = 12 \ V$						
Turn-off time $V_{\rm IN}$ to 10% $I_{\rm D}$: $t_{\rm off}$ - 60 1				100		
$R_{\rm L}$ = 4.7 Ω , $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V						
Slew rate on 70 to 50% V _{bb} :	-dV _{DS} /dt _{on}	_	0.4	1.5	V/µs	
$R_{\rm L}$ = 4.7 Ω , $V_{\rm IN}$ = 0 to 10 V, $V_{\rm bb}$ = 12 V						
Slew rate off 50 to 70% V _{bb} :	dV _{DS} /dt _{off}	-	0.6	1.5	1	
$R_{\rm L}$ = 4.7 Ω , $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V						
Protection Functions ¹⁾	•		•			
Thermal overload trip temperature	T_{it}	150	175	-	°C	
Thermal hysteresis ²⁾	ΔT_{it}	-	10	-	K	
Input current protection mode	/ _{IN(Prot)}	-	40	300	μA	
<i>T</i> _j = 150 °C						
Unclamped single pulse inductive energy ²⁾	E _{AS}	150	-	-	mJ	
$I_{\rm D}$ = 1.4 A, $T_{\rm j}$ = 25 °C, $V_{\rm bb}$ = 12 V						
Inverse Diode						
Inverse diode forward voltage	V _{SD}	-	1	1.5	V	
$I_{\rm F}$ = 7 A, $t_{\rm m}$ = 250 µs, $V_{\rm IN}$ = 0 V,						
$t_{\rm P} = 300 \; \mu {\rm s}$						

¹Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation

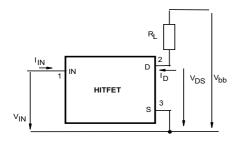
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²not subject to production test, specified by design

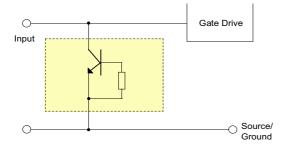


Block diagram

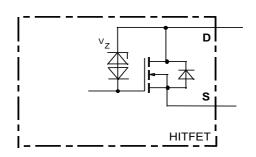
Terms



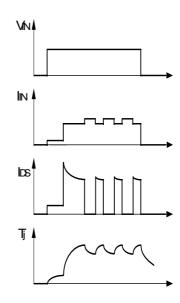
Input circuit (ESD protection)



Inductive and overvoltage output clamp



Short circuit behaviour

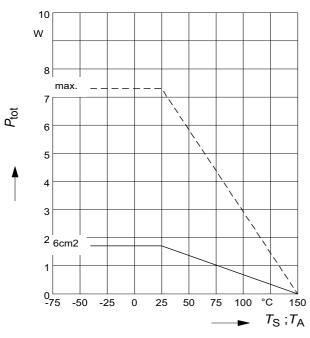




1 Maximum allowable power dissipation

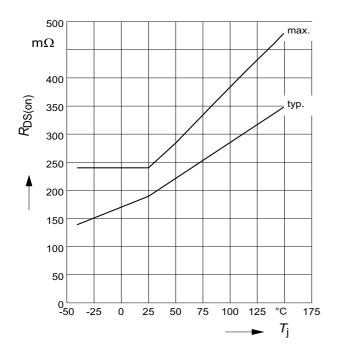
 $P_{tot} = f(T_S)$ resp.

 $P_{tot} = f(T_A) @ R_{thJA} = 72 \text{ K/W}$



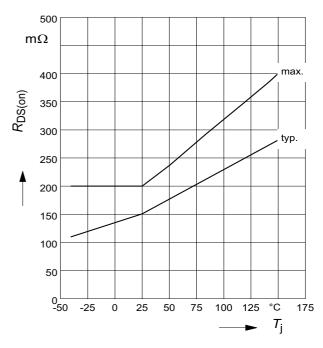
3 On-state resistance

 $R_{ON} = f(T_i); I_D = 1.4A; V_{IN} = 5V$



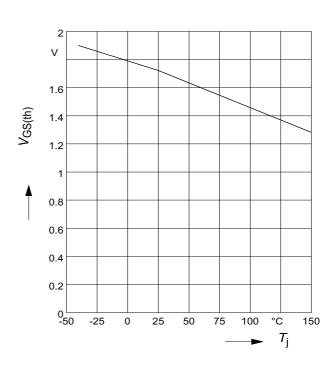
2 On-state resistance

 $R_{ON} = f(T_i); I_D = 1.4A; V_{IN} = 10V$



4 Typ. input threshold voltage

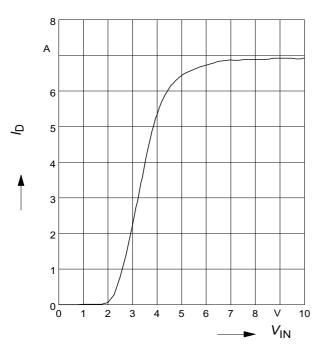
 $V_{IN(th)} = f(T_j); I_D = 0.15 \text{ mA}; V_{DS} = 12V$





5 Typ. transfer characteristics

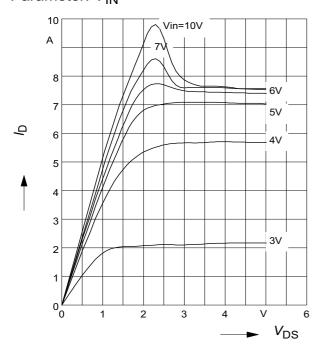
 $I_D=f(V_{IN}); V_{DS}=12V; T_{Jstart}=25^{\circ}C$



7 Typ. output characteristics

I_D=f(V_{DS}); T_{Jstart}=25°C

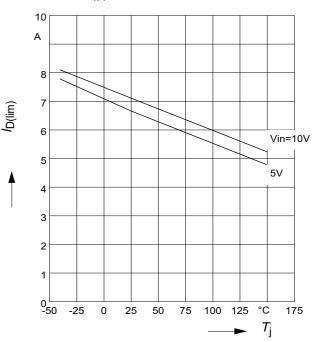
Parameter: V_{IN}



6 Typ. short circuit current

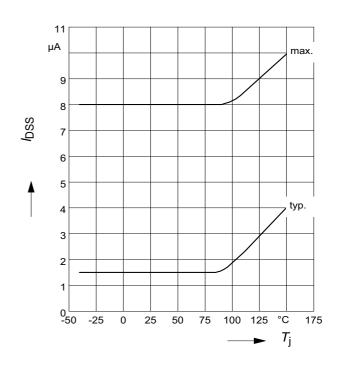
 $I_{D(lim)} = f(T_j); V_{DS} = 12V$

Parameter: V_{IN}



8 Off-state drain current

 $I_{DSS} = f(T_j)$

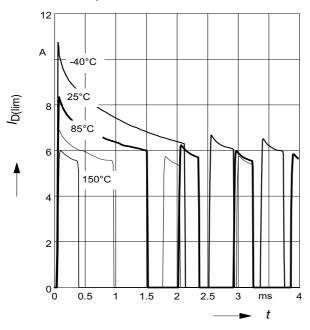




9 Typ. overload current

 $I_{D(lim)} = f(t)$, $V_{bb} = 12$ V, no heatsink

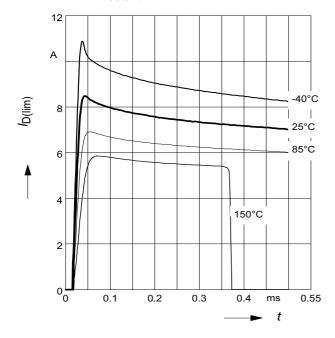
Parameter: T_{jstart}



11 Determination of $I_{D(lim)}$

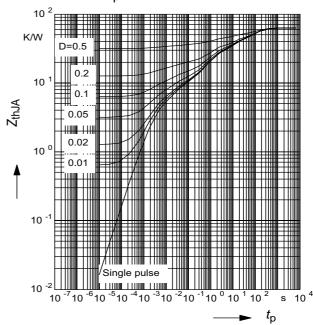
 $I_{D(lim)} = f(t); t_m = 200 \mu s$

Parameter: T_{Jstart}



10 Typ. transient thermal impedance Z_{thJA} =f(t_{p}) @ 6 cm² cooling area

Parameter: $D=t_p/T$





Package Outlines

1 Package Outlines

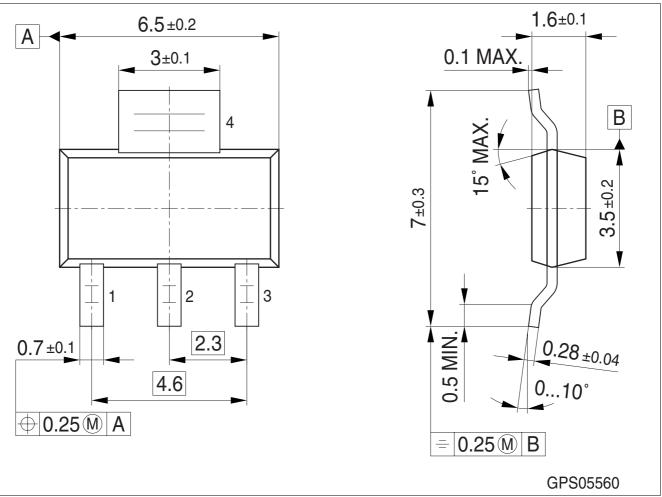


Figure 1 PG-SOT223-4 (Plastic Green Small Outline Transistor Package)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

Dimensions in mm



Revision History

2 Revision History

Version	Date	Changes
Rev. 1.3	2008-04-14	Package information updated to SOT223-4
Rev. 1.2	2007-03-28	released automotive green version Package parameter (humidity and climatic) removed in Maximum ratings AEC icon added RoHS icon added Green product (RoHS-compliant) added to the feature list Package information updated to green Green explanation added
Rev. 1.1	2004-03-05	released production version

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